

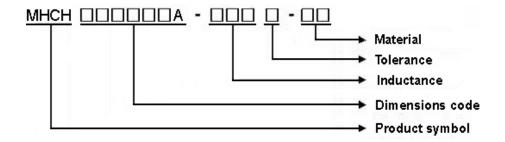
#### ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

# RoHS & Halogen Free & REACH Compliance.

# SPECIFICATION FOR APPROVAL

Customer :						
Customer P/N:			_			
Drawing No:						
Quantity:	X Pcs.	Date :	2015/01/28			
Quantity .		Date .	2015/01/20			
Chilisin P/N:	МНС	H201610A-I	R47M-A8			
	SPECIFICA	ATION				
	ACCEPTE					
COMPONENT						
ENGINEER						
ELECTRICAL						
ENGINEER						
MECHANICAL						
ENGINEER						
APPROVED						
REJECTED						
奇力新電子股份有限公司		艺奇力新電子有				
Chilisin Electronic sCorp	Chilis	sin Electronics (Do	ongguan) Co., Ltd.			
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FAX: +886-3-599-9176		: +86-769-8773-0 : +86-769-8773-				
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奇力新電子(河南)有限公	河 <del>本+</del>	刀新電子(蘇州)	· 右限八司			
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TEL:+86-391-717-0682 FAX:+86-391-717-0666		+86-512-6841-23	50			
		:+86-512-6841-23 ail:suzhou@chili:				
Danier I		le c	A			
		-				
Drawn by 張鈺雯 <b>chang.yuwen</b>	Checked 張鈺雯 chang	-	Approved 鍾瑞民 <b>jacky</b> .			

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature:  $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$  (Including self - temperature rise)

Storage Temperature:  $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$  (after PCB)

 $-5\,^{\circ}\mathrm{C} \sim 3\,\,5\,^{\circ}\mathrm{C}$  ,Humidity  $\,4\,\,5\,\% \sim 8\,\,5\,\%$  (before PCB)

4 Marking:

No Marking

## 5 Standard Testing Condition

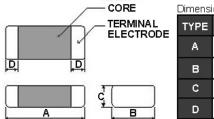
	In case of doubt	
Temperature	Ordinary Temperature(15 to 35°ℂ)	20±2℃
Humidity	Ordinary Humidity(25 to 85% RH)	60 to 70 % RH



#### ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

# **MHCH201610A Series Specification**

# 6 Configuration and Dimensions:



	Dimensions in mm					
	TYPE	MHCH201610A				
'	Α	2.0 <u>+</u> 0.2				
	В	1.6 ±0.2				
	O	1.0 Max.				
	D	0.5±0.3				

#### 7 Electrical Characteristics:

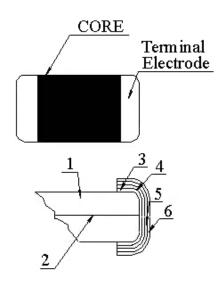
#### NOTE

- 1.Operating temperature range  $-4~0~\text{°C} \sim 1~2~5~\text{°C}$  (Including self temperature rise)
- 2.Isat for Inductance drop 30% from its value without current.
- 3.Irms for a 40  $^{\circ}\mathrm{C}$  temprature rise from 25  $^{\circ}\mathrm{C}$  ambient.
- 4.All test data is referenced to 25°C ambient



# 8 MHCH201610A Series

#### 8.1 Construction:



#### 8.2 Material List:

NO	Part	Description
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn

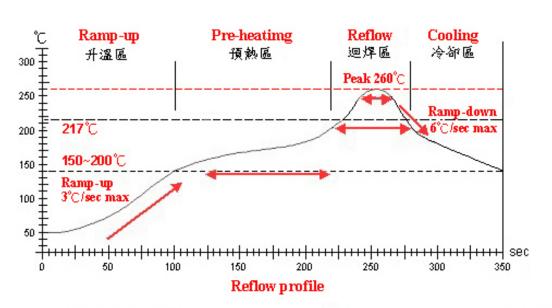


# 9 Reliability of molding power inductors 1-1.Mechanical Performance

No	ltem	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate
		conditions must not damage	Substrate Dimension: 100x40x1.6mm
		the terminal electrode and the	Deflection: 2.0mm
		metal body	Keeping Time: 30sec
1-1-2	Vibration		Test device shall be soldered on the substrate
			Oscillation Frequency: 10 to 55 to 10Hz for 1min
			Amplitude: 1.5mm
			Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150℃, 1min
		More than 75% of the terminal	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		electrode should be covered	Solder Temperature: 260±5℃
		with solder.	Immersion Time: 10±1sec
		Inductance: within ±20% of	
		initial value	
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150℃, 1min
		least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		solder coating	Solder Temperature: 245±5℃
			Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate,
		Chip	then apply a force in the direction of the arrow.
			Force : 5N
		F	Keeping Time: 10±1sec
		Mounting Pad	

#### 1-2 Environmental Performance

No	Item	Specification	Test Method					
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:					
		Inductance:within±20% of	Step	Temperature (°ℂ)	Time (min)			
		initial value	1	-40±3	30			
			2	25±2	2			
			3	125±3	30			
			4	25±2	2			
			Total: 100c	cycles	•			
			Measured	after exposure in the room cor	dition for 24hrs			
1-2-2	Humidity Resistance		Temperature: 60±2°C					
			Relative Hu	Relative Humidity: 90 ~ 95% / Time: 500hrs				
			Measured	Measured after exposure in the room condi				
1-2-3	High		Temperature: 85±3°C					
	Temperature Resistance		Relative Hu	umidity: 0% / Time: 500hrs				
			Measured after exposure in the room condition for 12					
1-2-4	Low		Temperature: -40±3°C					
	Temperature Resistance	l · · · · · · · · · · · · · · · · · · ·						
Measured after exposure in the					m condition for 12hrs			



#### Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
温度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	217℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	_
實際時間 Time result	_	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	_

#### NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



#### ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

# **MHCH201610A Series Specification**

10 Test Data for Pre-production Samples

Chilisin P/N: MHCH201610A-R47M-A8											
Measi Itei		L0 (uH)	L1 (uH)Max.	RDC (mΩ)Max.	A m/m	B m/m	C m/m	D m/m			
Spec Cus	stomer	0.47±20%									
Suç	ggest		L0*0.7	32(26typ)	2.0±0.2	1.6±0.2	1.0 Max.	0.5±0.3			
Test F	Freq.	Isat=0A 2MHz 0.2V	Isat=4.8A 2MHz 0.2V								
1		0.495	0.353	26.1	2.15	1.78	0.98	0.48			
2		0.431	0.314	25.7	2.14	1.78	0.97	0.46			
3		0.477	0.345	25.1	2.14	1.78	0.96	0.46			
4		0.482	0.350	25.6	2.14	1.79	0.96	0.48			
5	,	0.472	0.353	25.8	2.14	1.78	0.98	0.49			
6	;										
7	,										
8	}										
9	)										
10	)										
11	1										
12	2										
13	3										
14	4										
15	5										
X	(	0.4714	0.343	25.66	2.142	1.782	0.97	0.474			
R	2	0.064	0.039	1	0.01	0.01	0.02	0.03			
Custo	mer										
Sam	ple										

#### Test Instrument

L : Agilent E4991A/HP4287A+16197A RDC : CHEN HWA 502BC / HP4338B Isat : Agilent E4980A+HP42841A

Irms: Agilent 6641 SYSTEM DC POWER SUPPLY

#### Appearance and Dimensions:

SPEC: Refer to Item 6

Test Method: Visual Inspection and Measured with Slide Calipers.

#### Test Conditions:

	Unless Otherwise Specified	In Case of Doubt
Temperature	Ordinary Temperature (15 to 35°C)	20 ± 2 ℃
Humidity	Ordinary Humidity (25 to 85 %RH)	60 to 70 %RH



# 11 Packaging:

#### 11.1 Packaging -Cover Tape

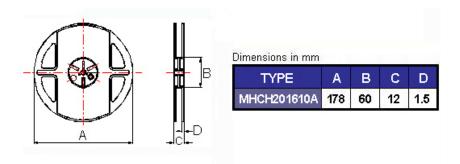
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



#### 11.2 Packaging Quantity

TYPE	BULK	PCS/REEL
MHCH201610A	✓	3000

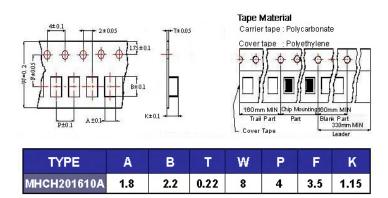
#### 11.3 Reel Dimensions



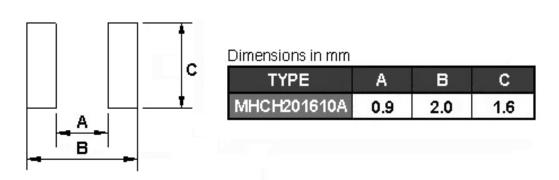


# 11 Packaging:

#### 11.4 Tape Dimensions in mm



## 12 Recommended Land Pattern:



## 13 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglectable.





